

INFORMATION DISCLOSURE CITATION
(Use several sheets if necessary)

ATTY DOCKET NO.

EN9-99-073052

SERIAL NO.

10/79495

David J. Alcoe et al.

FILING

11-21-03

GROUP

2813

U.S. PATENT DOCUMENTS

| EXAMINER INITIAL | DOCUMENT NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE |
|---------------------|-----------------|---------|---------------------|-------|----------|-------------------------------|
| OA | 5,906,042 | 5/1999 | Lan et al. | / | / | |
| | 5,900,675 | 5/1999 | Appelt et al. | / | / | |
| | 5,894,173 | 4/1999 | Jacobs et al. | / | / | |
| | 5,876,842 | 3/1999 | Duffy et al. | / | / | |
| | 5,798,563 | 8/1998 | Feilchenfeld et al. | / | / | |
| | 5,792,705 | 8/1998 | Wang et al. | / | / | |
| | 5,574,630 | 11/1996 | Kresge et al. | / | / | |
| | 5,615,087 | 3/1997 | Wieloch | / | / | |
| | 5,121,190 | 6/1992 | Hsiao et al. | / | / | |
| DA | 5,072,075 | 12/1991 | Lee et al. | / | / | |

FOREIGN PATENT DOCUMENTS

| | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUBCLASS | TRANSLATION | |
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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EXAMINER

DATE CONSIDERED

6-25-04

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INFORMATION DISCLOSURE CITATION
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Docket Number (Optional)

EN9-99-073052

Application Number

10/11/94 495

Applicant(s)

Alcoe et al

Filing Date

11-21-03

Group Art Unit

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2813

U.S. PATENT DOCUMENTS

| EXAMINER INITIAL | REF | DOCUMENT NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE |
|---------------------|-----|-----------------|------|------|-------|----------|-------------------------------|
| | AA | | | | | | |
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FOREIGN PATENT DOCUMENTS

| REF | DOCUMENT NUMBER | DATE | COUNTRY | CLASS | SUBCLASS | Translation | |
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| | | | | | | YES | NO |
| AL | | | | | | | |
| AM | | | | | | | |
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| AO | | | | | | | |
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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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|----|----|---|
| DA | AI | "High Performance Carrier Technology: Materials And Fabrication", by Light et al, 1993 International Electronics Packaging Conference, San Diego, California, Volume One. |
| DA | AS | "High Performance Carrier Technology", by Heck et al, 1993 International Electronics Packaging Conference, San Diego, California, Volume One. |

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EN9-99-073052

Application Number

10/719495

Applicant(s)

Alcoa et al

Filing Date

11-21-03

Group Art Unit

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U.S. PATENT DOCUMENTS

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|---------------------|-----|-----------------|------|------|-------|----------|-------------------------------|
| | AA | | | | | | |
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FOREIGN PATENT DOCUMENTS

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OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

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|----|----|---|
| DA | AR | "Process Considerations in the Fabrication of Teflon Printed Circuit Boards", by Light et al, 1994 Proceedings, 44 Electronic Components & Technology Conference, 5/94. |
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